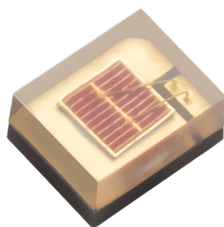


PRODUCT SPECIFICATION



Part No.: WL-3P2016EP140IR-770
SMD High Power LED

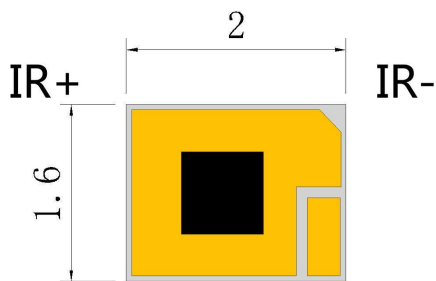
Catalog

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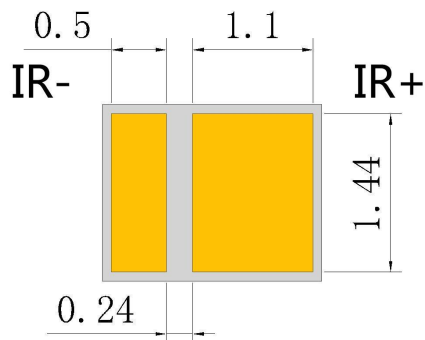
1.Product Features

- High Brightness IR LED Round Package
- Viewing Angle 140 Degree
- Transparent Silicone
- Chip Material: AlGaAs
- RoHS Compliant

2.Dimensions



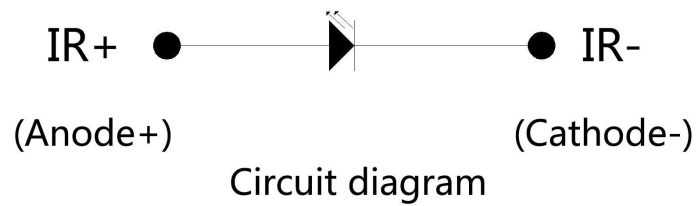
Top view



Bottom view



Side view



Notes:

1. All dimensions are in millimeters.
2. Tolerance is $\pm 0.1\text{mm}$ unless otherwise noted.

3. Absolute Maximum Rating @ Ta=25° C

Parameter	Symbol	Maximum Rating	Unit
Continuous Forward Current	IF	700	mA
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	IFp	1000	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	1.5	W
Electrostatic Discharge	ESD	1000	V
Operating Temperature Range	TOPR	-25°C to +80°C	
Storage Temperature Range	TSTG	-35°C to +100°C	
Lead Soldering Temperature	TSOL	260°C	

4. Optical Character @ Ta=25° C

Parameter	Symbol	Color	Min.	Typ.	Max.	Unit	Test Condition
Forward Voltage	VF	IR	1.8	2.0	2.2	V	IF=700mA
Peak Wavelength	WIP	IR	770	773	775	nm	IF=700mA
Radiant Power	PO	IR	250	300	350	mW	IF=700mA
Reverse Current	IR		0		10	μA	VR=5V
Viewing Angle	2θ1/2				140	deg	IF=700mA
Recommend Forward Current	IF(rec)	IR			700	mA	

Notes:

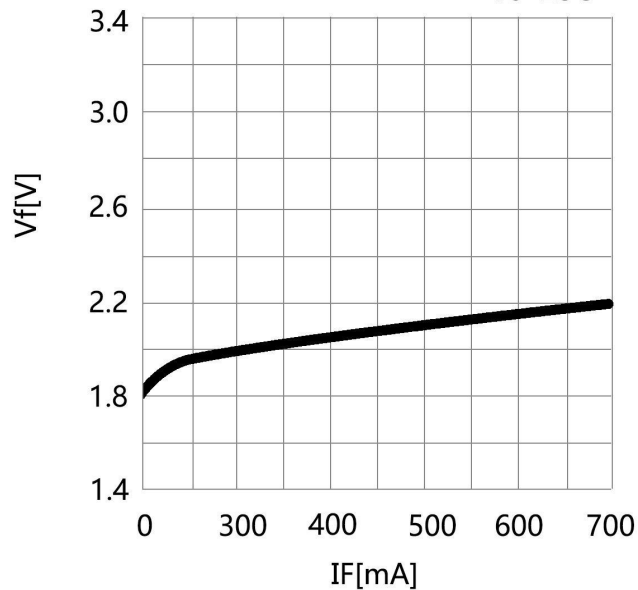
Measurement tolerance of forward voltage ±0.1V

5. Optical Character Curves

(25 ° Ambient Temperature Unless Otherwise Noted)

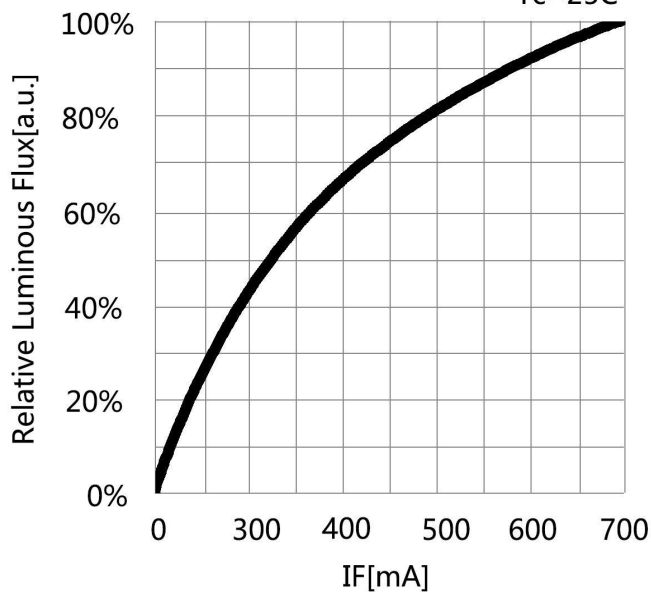
Forward Current vs. Forward Voltage

$T_c = 25^\circ\text{C}$



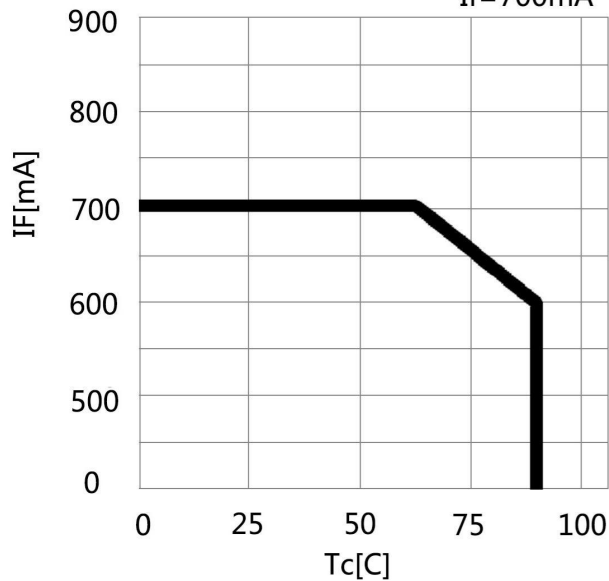
Forward Current vs. Relative Luminous Flux

$T_c = 25^\circ\text{C}$



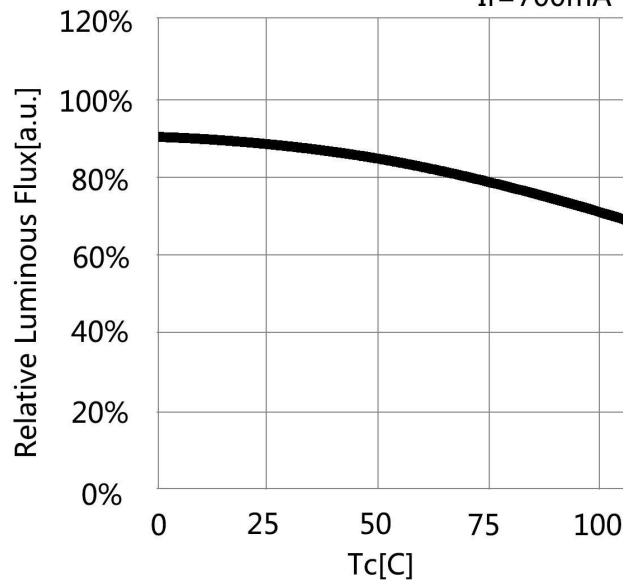
Case Temperature vs. Forward Current

$I_f = 700\text{mA}$

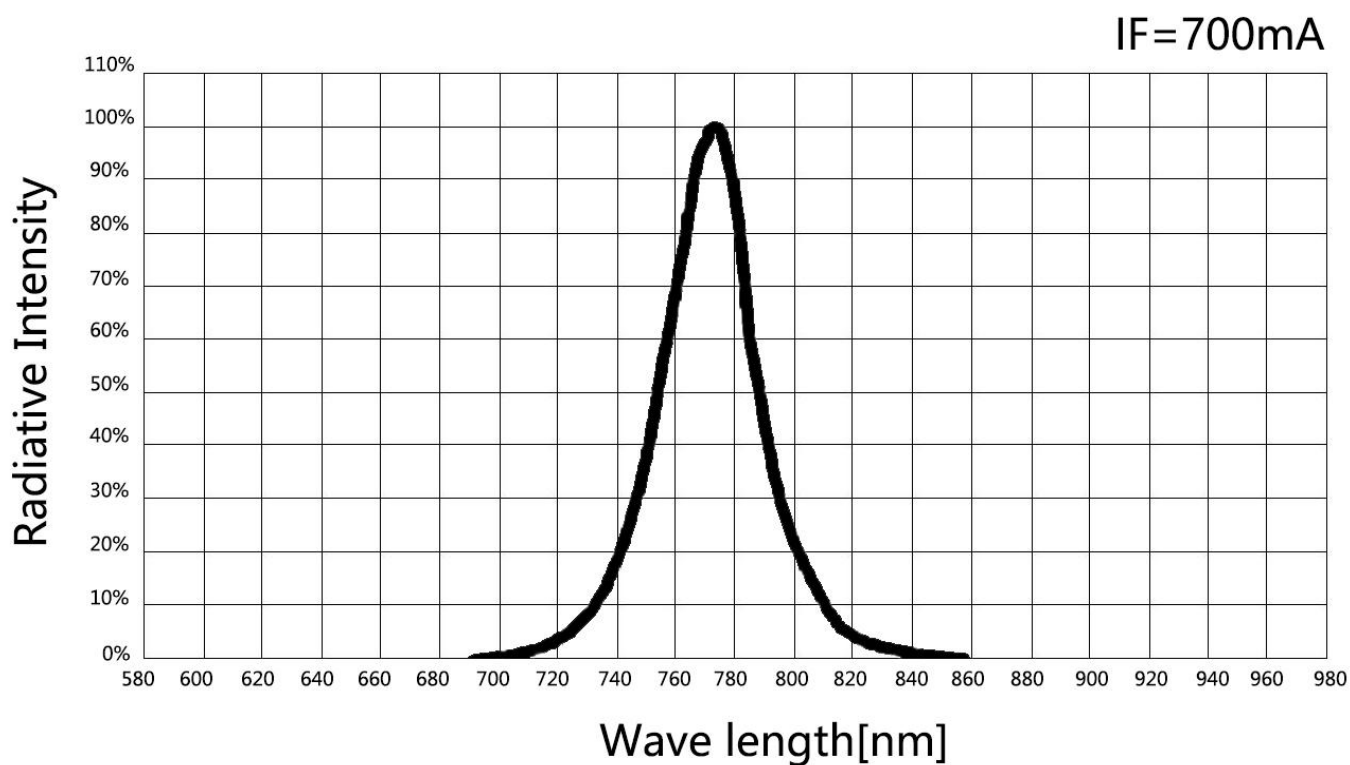


Case Temperature vs. Relative Luminous Flux

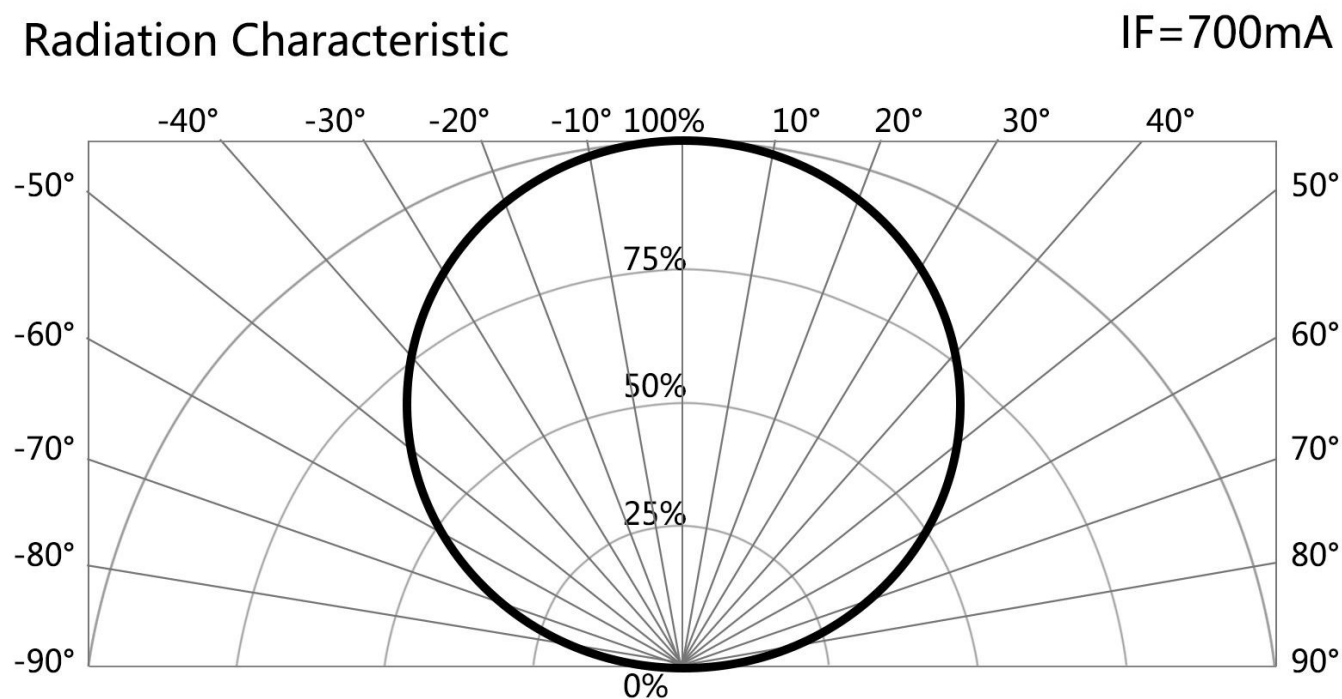
$I_f = 700\text{mA}$



6. Spectrum Curves

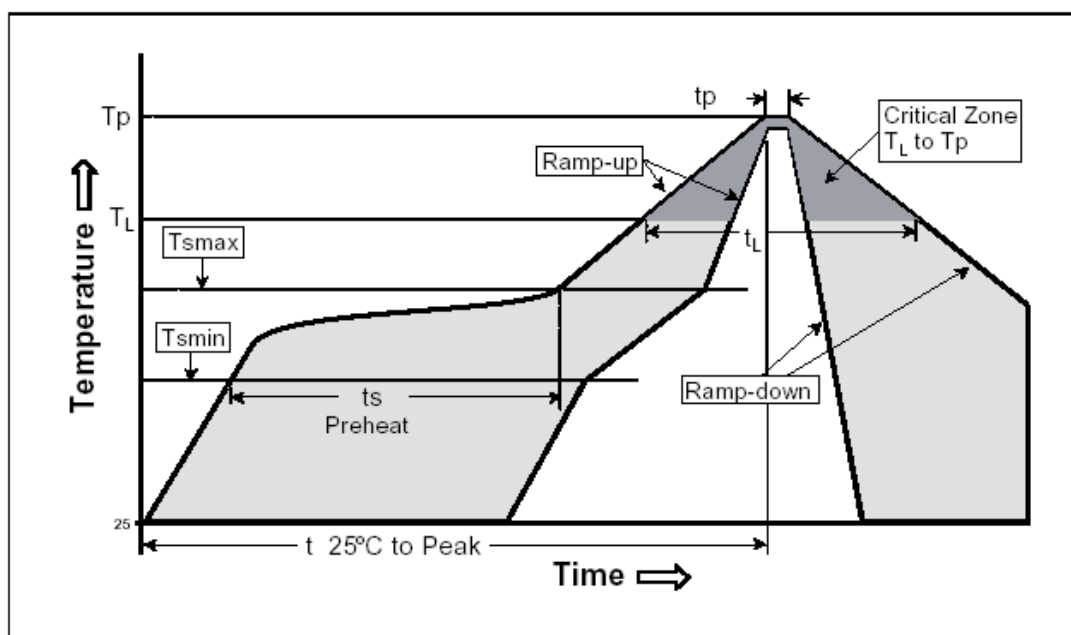


7. Viewing Angle Curves



8.Soldering Advice

1. When soldering, don't touch the LED appearance gel during, this bad operation will destroy the LED. Moding LED usually use reflow soldering, please refer to the following reflow temperature curve , and recommend the user follow the soldering temperature curve of the solder paste.



Temperature Curve Character	Lead-free solder
Average heating rate(T_{smin} to T_p)	Top 3 °C / s
Preheating: Minimum temperature (T_{smin})	90°C
Preheating: Maximum temperature (T_{smax})	200°C
Preheating: Time (T_{smin} to T_{smax})	60-180 s
Duration above temperature: Temperature T_L	240°C
Duration above temperature: Time t_L	60-150 s
Peak/classification temperature (T_p)	260°C
Time within 5°C of actual peak temperature (t_p)	20-40 s
Cooling speed	The highest 6 °C / s
Time to reach peak temperature at 25°C	8 minutes Max

9. Cautions

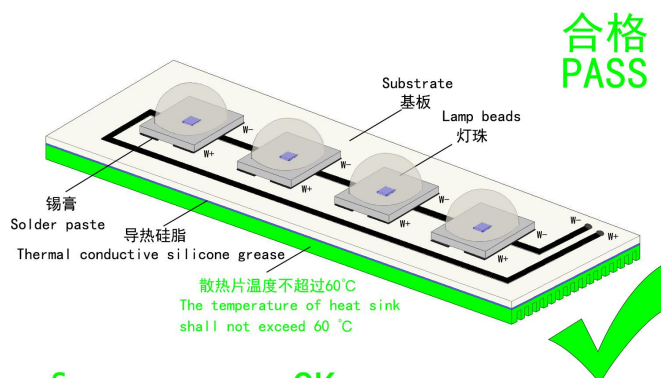
1. Electrostatic Treatment

Do a full range of anti-static measures (such as: anti-static ring, anti-static clothes, machine, equipment grounding wire, etc.)



2. Heat Dissipation

- A、 It is recommend to configure reasonable heat dissipation device for the product.
- B、 The best working temperature range of the product is 40-60°. It is recommended to control the working temperature of the product within a reasonable range.



3. Installation Conditions

reference OK

- A、 Do not exert any pressure on the LED area during the use of the led beads. If the machine is used to take materials, select a suction nozzle of reasonable size, such as below:

